MATERIAL:
INSULATOR:PBT+30% GLASS FIBER(UL94V-0).
Terminal:Copper Alloy
CONTACPLATED:GOLD OVER NICKELOR TIN
SHELL:STEEL,nickel
SPESIFICATION:
CURRENT RATE:5 AMPS
INSULATOR RESISTANCE:1000M MIN.AT 500V DC
DIELLECTRIC STRENGTH:1000V PER
OPERTION TEMPERATURE:-55°C TO+105°C
IMPEDANCE:16M FOR 25MHz

ORDER INFORMATION

D B R 1 - M X X X B X X - L

◎:Standard Recommend

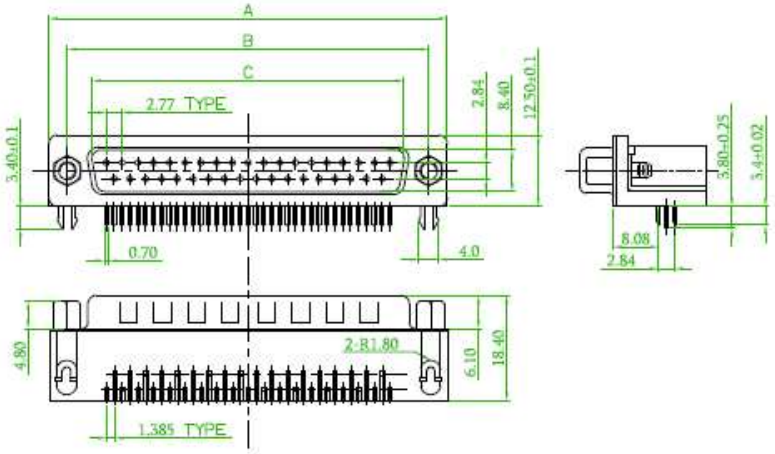
No, of contacts

◎Gold flash	S:Selective
GA:5u"	SA:5u"
GB:10u"	SB:10u"
GC:20u"	SC:20u"
GD:30u"	SD:30u"

B:Black Insulator

1:Fork grounding

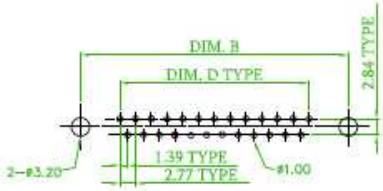
L:RoHS + P,B,T



7.2mm Footprint

Dimensions

Positions	A	B	C
9	30.80	24.99	16.90
15	39.20	33.32	25.30
25	53.10	47.04	39.00
37	70.00	63.50	55.40



RECOMMENDED PC BORAD LAYOUT
APPLICATIONS: PC BOARD THICKNESS-1.60mm

AREA	REV.	DESCRIPTION	DATE
B	B	Delete the Tin Plating Options	

品名 TITLE	D-SUB RIGHT ANGLE TYPE 7,2mm MALE				
品號 PART NO.	DBR1-MXX-L			日期 DATE	2008/11/18
圖號 DRAWING NO.	DBR1-MXX-L	版本 REV.	B	繪圖 DRAWN	
客戶品號 CUSTOMER P/N		比例 SCALE	FREE	核對 CHECKED	
公差 TOLERANCE	.X ±0.20 .XX ±0.15	單位 UNIT	mm	核准 APPROVED	